



# Product Change Notification

**Change Notification #:** 114571 - 00  
**Change Title:** Intel® NUC Board NUC5i3MYBE and Intel® NUC Kit NUC5i3MYHE, PCN 114571-00, Product Design, Label, Product Material, Firmware Update, Adapter update, Labeling update  
**Date of Publication:** May 04, 2016

## Key Characteristics of the Change:

Product Design, Label, Product Material

## Forecasted Key Milestones:




<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	May 20, 2016
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## Description of Change to the Customer:

The Intel® NUC Board SKUs listed in the products affected table below will have the following changes.

1. The firmware will be updated from MYBDWI30.86A.0028 to MYBDWI30.86A.0036 for Windows 10 support. To access the release notes or get a copy of the BIOS for evaluation, go to <http://downloadcenter.intel.com>.
2. Add India BIS label on power brick, add new India adapter, change plug orientation of Australia adapter

Item	Before	After
India BIS Label Placement		

India Adapter	NA	
Australia Adapter		

3. Move the Cal prop 65 warning label from the wrap to the pretty box.
4. Remove NFC header

### Customer Impact of Change and Recommended Action:

These changes have been thoroughly evaluated to ensure there is no quality, reliability, or functional implication to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

### Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change SA	Pre Change AA	Post Change SA	Post Change AA
BLKNUC5I3MYHE	938715	H52443-204	H47781-204	H52443-205	H47781-205
BLKNUC5I3MYBE	938717		H47781-204		H47781-205

### PCN Revision History:

**Date of Revision:**

May 4, 2016

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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